

## Diode Modules

## PSKD 56

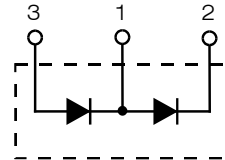
$$I_{FRMS} = 2x 150 A$$

$$I_{FAVM} = 2x 95 A$$

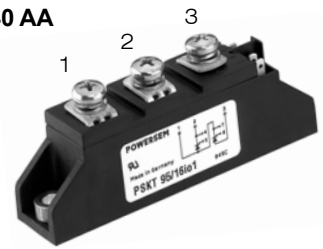
$$V_{RRM} = 800-1800 V$$

Preliminary Data Sheet

$V_{RSM}$ V	$V_{RRM}$ V	Type
900	800	PSKD 56/08
1300	1200	PSKD 56/12
1500	1400	PSKD 56/14
1700	1600	PSKD 56/16
1900	1800	PSKD 56/18



TO-240 AA



Symbol	Test Conditions	Maximum Ratings	
$I_{FRMS}$	$T_{VJ} = T_{VJM}$	150 A	
$I_{FAVM}$	$T_C = 75^{\circ}C$ ; 180° sine	95 A	
	$T_C = 100^{\circ}C$ ; 180° sine	71 A	
$I_{FSM}$	$T_{VJ} = 45^{\circ}C$ ; $V_R = 0$	t = 10 ms (50 Hz), sine t = 8.3 ms (60 Hz), sine	1400 A 1650 A
	$T_{VJ} = T_{VJM}$ ; $V_R = 0$	t = 10 ms (50 Hz), sine t = 8.3 ms (60 Hz), sine	1200 A 1400 A
$\int i^2 dt$	$T_{VJ} = 45^{\circ}C$ ; $V_R = 0$	t = 10 ms (50 Hz), sine t = 8.3 ms (60 Hz), sine	9800 A <sup>2</sup> s 11300 A <sup>2</sup> s
	$T_{VJ} = T_{VJM}$ ; $V_R = 0$	t = 10 ms (50 Hz), sine t = 8.3 ms (60 Hz), sine	7200 A <sup>2</sup> s 8100 A <sup>2</sup> s
$T_{VJ}$		-40...+150 °C	
$T_{VJM}$		150 °C	
$T_{stg}$		-40...+125 °C	
$V_{ISOL}$	50/60 Hz, RMS $I_{ISOL} \leq 1 mA$	t = 1 min t = 1 s	3000 V~ 3600 V~
$M_d$	Mounting torque (M5) Terminal connection torque (M5)		2.5-4/22-35 Nm/lb.in. 2.5-4/22-35 Nm/lb.in.
Weight	Typical including screws		90 g

### Features

- International standard package JEDEC TO-240 AA
- Direct copper bonded Al<sub>2</sub>O<sub>3</sub> -ceramic base plate
- Planar passivated chips
- Isolation voltage 3600 V~
- UL registered, E 148688

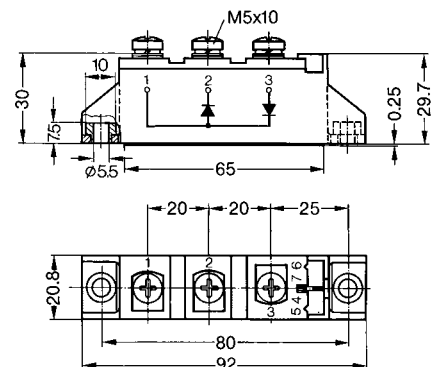
### Applications

- Supplies for DC power equipment
- DC supply for PWM inverter
- Field supply for DC motors
- Battery DC power supplies

### Advantages

- Space and weight savings
- Simple mounting
- Improved temperature and power cycling
- Reduced protection circuits

### Dimensions in mm (1 mm = 0.0394")



Symbol	Test Conditions	Characteristic Values
$I_R$	$T_{VJ} = T_{VJM}$ ; $V_R = V_{RRM}$	10 mA
$V_F$	$I_F = 200 A$ ; $T_{VJ} = 25^{\circ}C$	1.48 V
$V_{TO}$	For power-loss calculations only	0.8 V
$r_T$	$T_{VJ} = T_{VJM}$	3 mΩ
$Q_S$	$T_{VJ} = 125^{\circ}C$ ; $I_F = 50 A$ , $-di/dt = 3 A/\mu s$	100 μC
$I_{RM}$		24 A
$R_{thJC}$	per diode; DC current	0.51 K/W
	per module	0.255 K/W
$R_{thJK}$	per diode; DC current	0.71 K/W
	per module	0.355 K/W
$d_s$	Creepage distance on surface	12.7 mm
$d_A$	Strike distance through air	9.6 mm
$a$	Maximum allowable acceleration	50 m/s <sup>2</sup>

Data according to IEC 60747 and refer to a single thyristor/diode unless otherwise stated.

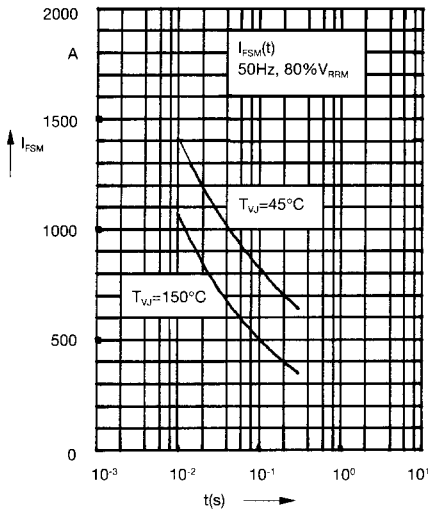


Fig. 1 Surge overload current  
 $I_{FSM}$ : Crest value, t: duration

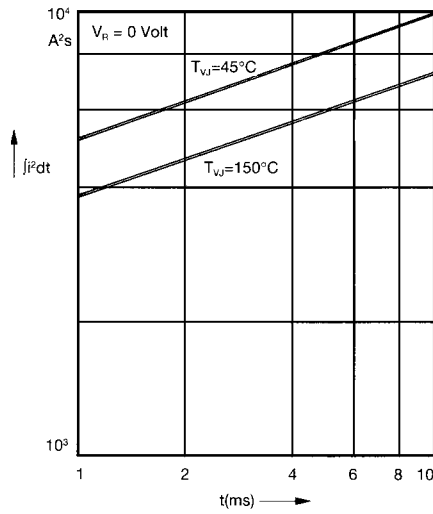


Fig. 2  $j^2dt$  versus time (1-10 ms)

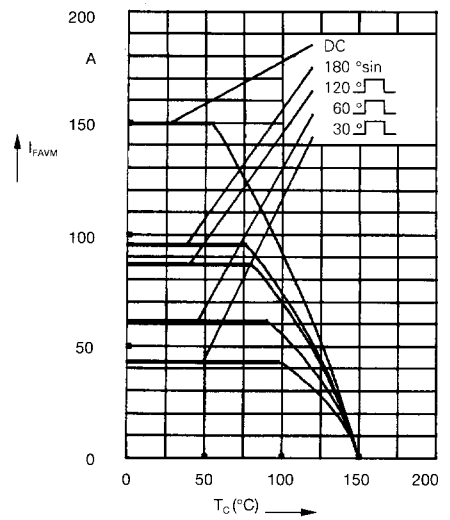


Fig. 2a Maximum forward current at case temperature

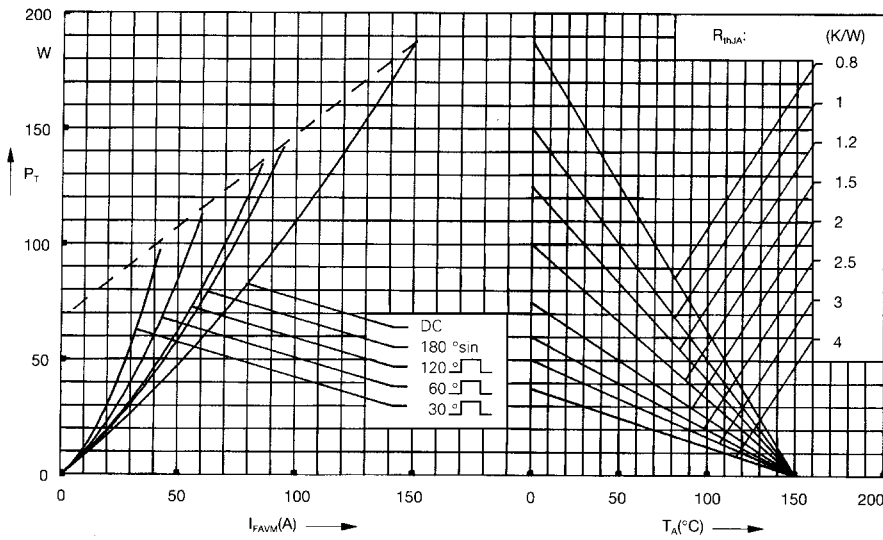


Fig. 3 Power dissipation versus forward current and ambient temperature (per diode)

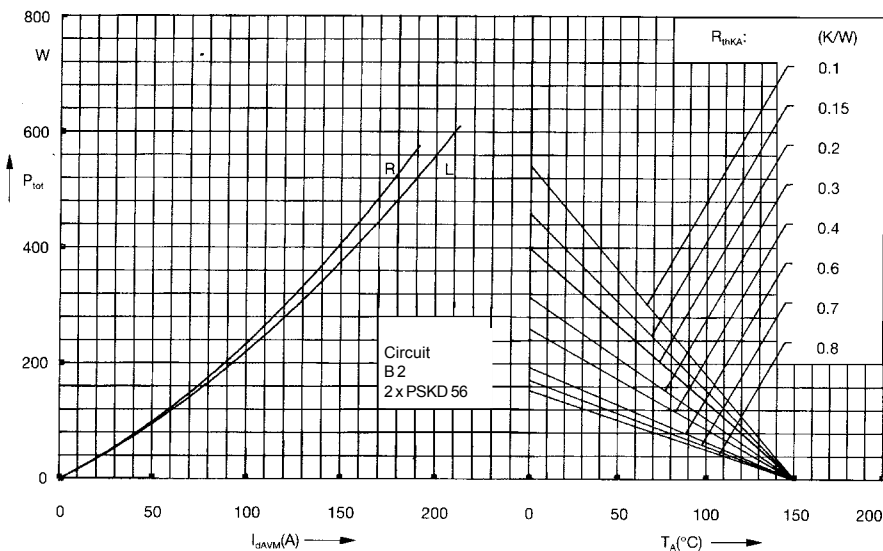


Fig. 4 Single phase rectifier bridge:  
 Power dissipation versus direct output current and ambient temperature  
 R = resistive load  
 L = inductive load

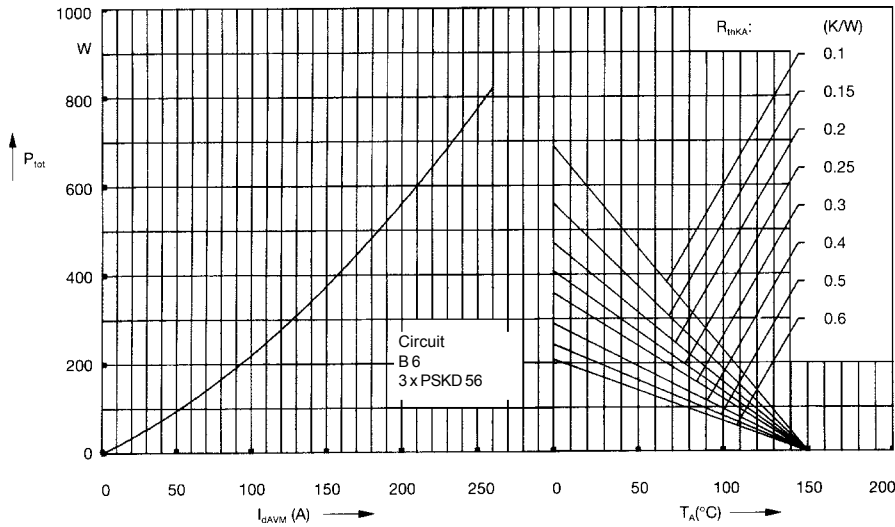


Fig. 5 Three phase rectifier bridge: Power dissipation versus direct output current and ambient temperature

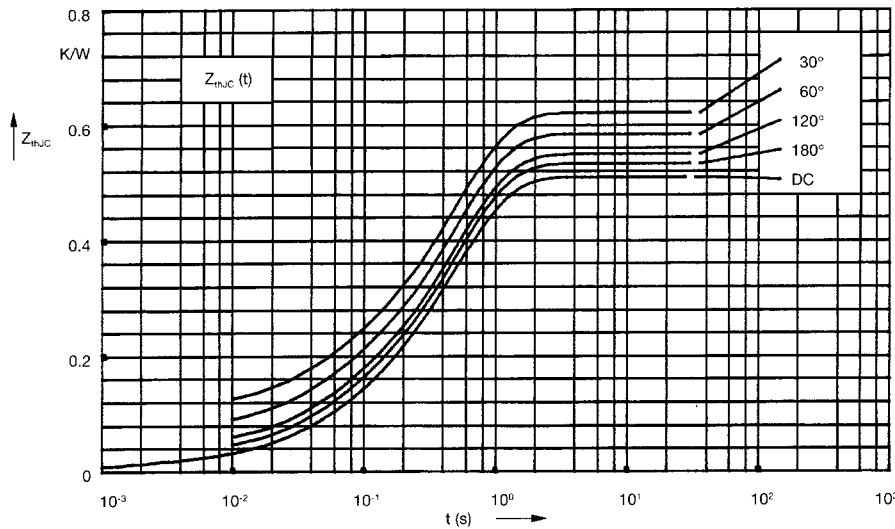


Fig. 6 Transient thermal impedance junction to case (per diode)

$R_{thJC}$  for various conduction angles d:

d	$R_{thJC}$ (K/W)
DC	0.51
180°	0.53
120°	0.55
60°	0.58
30°	0.62

Constants for  $Z_{thJC}$  calculation:

i	$R_{thi}$ (K/W)	$t_i$ (s)
1	0.013	0.0015
2	0.055	0.045
3	0.442	0.485

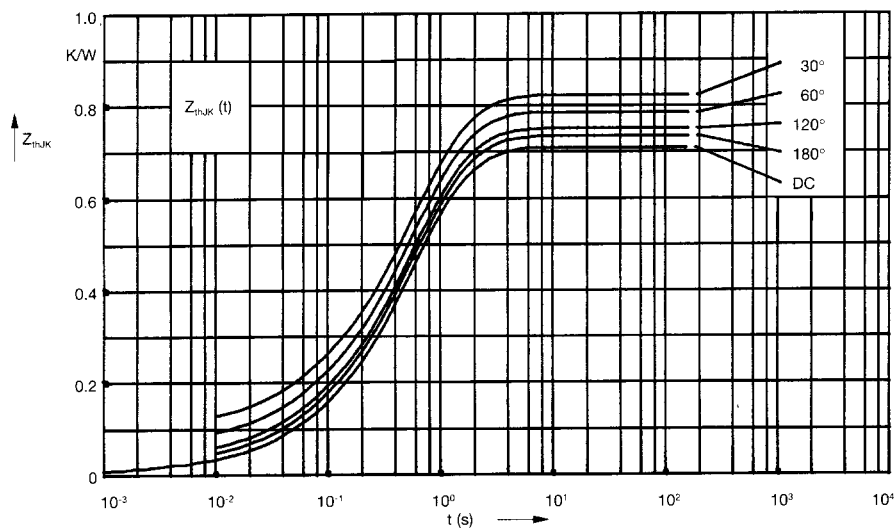


Fig. 7 Transient thermal impedance junction to heatsink (per diode)

$R_{thJK}$  for various conduction angles d:

d	$R_{thJK}$ (K/W)
DC	0.71
180°	0.73
120°	0.75
60°	0.78
30°	0.82

Constants for  $Z_{thJK}$  calculation:

i	$R_{thi}$ (K/W)	$t_i$ (s)
1	0.013	0.0015
2	0.055	0.045
3	0.442	0.485
4	0.2	1.25